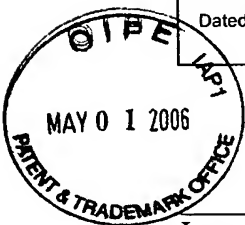


I hereby certify that this correspondence is being deposited with the U.S. Postal Service with sufficient postage as First Class Mail, in an envelope addressed to: MS Amendment, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on the date shown below.

Dated: April 28, 2006

Signature: Richard H. Anderson
(Richard H. Anderson)

Docket No.: 27702/10047C-1
(PATENT)



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:
Gary Wentworth et al.

Application No.: 10/706,386

Confirmation No.: 6381

Filed: November 12, 2003

Art Unit: 1614

For: LIQUID FORM ESTER/RESIN ADHESION
PROMOTER

Examiner: S. K. Poulos

AMENDMENT IN RESPONSE TO NON-FINAL OFFICE ACTION

MS Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

INTRODUCTORY COMMENTS

In response to the Office Action dated February 22, 2006, please amend the above-identified U.S. patent application as follows:

The **Complete Listing of Claims** begins on page 2 of this paper.

Remarks begin on page 26 of this paper.